

HOSTAFORM® SlideX® C0313 XAP®2

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POM copolymer Injection molding grade with tribological modification for demanding applications that require prevention of audible noise caused by stick-slip phenomenon. Excellent tribological performance with low friction and low wear under various conditions of sliding against plastics and metals. Reduced emission grade. Emissions according to VDA 275 < 5 mg/kg. Material is also food contact compliant in certain countries and for certain conditions of use (contact Celanese for further information).

Chemical abbreviation according to ISO 1043-1: POM Molding compound ISO 29988-1: POM-K | M-GNRS2 | 4-2 | - | POM copolymer

Product information

Resin Identification	POM	ISO 1043
Part Marking Code	>POM<	ISO 11469

Rheological properties

Melt volume-flow rate	13 cm ³ /10min	ISO 1133
Temperature	190 °C	
Load	2.16 kg	
Moulding shrinkage, parallel	2.0 %	ISO 294-4, 2577
Moulding shrinkage, normal	1.6 %	ISO 294-4, 2577

Typical mechanical properties

Tensile modulus	2700 MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	60 MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	13 %	ISO 527-1/-2
Nominal strain at break	40 %	ISO 527-1/-2
Flexural modulus	2550 MPa	ISO 178
Compressive stress at 1% strain	25 MPa	ISO 604
Charpy impact strength, 23°C	150 kJ/m ²	ISO 179/1eU
Charpy impact strength, -30°C	140 kJ/m ²	ISO 179/1eU
Charpy notched impact strength, 23°C	6 kJ/m ²	ISO 179/1eA
Charpy notched impact strength, -30°C	6 kJ/m ²	ISO 179/1eA
Ball indentation hardness, H 358/30	140 MPa	ISO 2039-1
Poisson's ratio	0.38 ^[C]	

[C]: Calculated

Thermal properties

Melting temperature, 10°C/min	170 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	93 °C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	157 °C	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	130 E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE), normal	130 E-6/K	ISO 11359-1/-2

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Flammability

FMVSS Class	B	ISO 3795 (FMVSS 302)
Burning rate, Thickness 1 mm	49.6 mm/min	ISO 3795 (FMVSS 302)

Physical/Other properties

Humidity absorption, 2mm	0.2 %	Sim. to ISO 62
Water absorption, 2mm	0.65 %	Sim. to ISO 62
Density	1400 kg/m ³	ISO 1183

Injection

Drying Recommended	no
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	3 - 4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	200 °C
Min. melt temperature	190 °C
Max. melt temperature	210 °C
Screw tangential speed	≤0.3 m/s
Mold Temperature Optimum	100 °C
Min. mould temperature	80 °C
Max. mould temperature	120 °C
Hold pressure range	60 - 120 MPa
Back pressure	4 MPa
Ejection temperature	138 °C

Characteristics

Processing	Injection Moulding
Delivery form	Granules
Special characteristics	Low wear / Low friction, Low emissions

Additional information

Injection molding

Processing

See Processing Guide and Involve Celanese FTS support to obtain best quality parts

Processing Notes

Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems

Storage

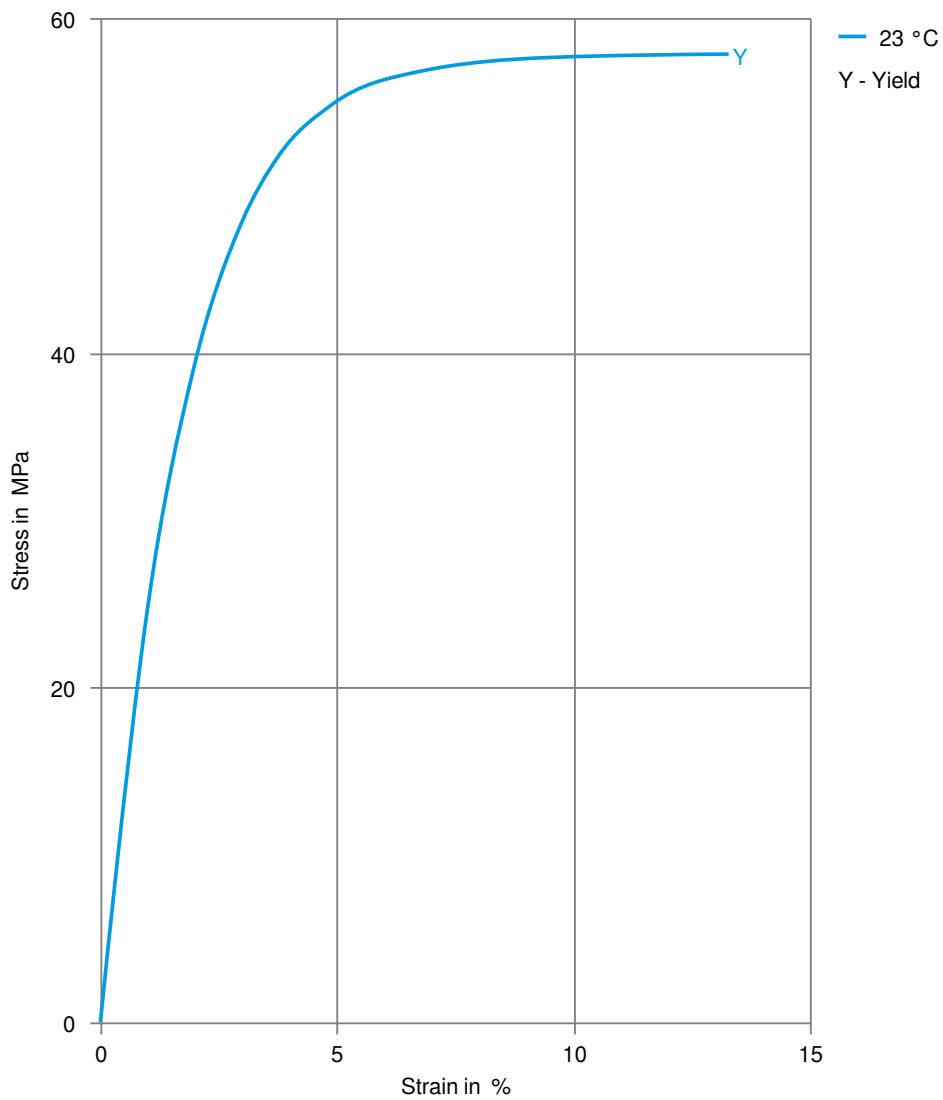
The product can then be stored in standard conditions until processed.

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Automotive

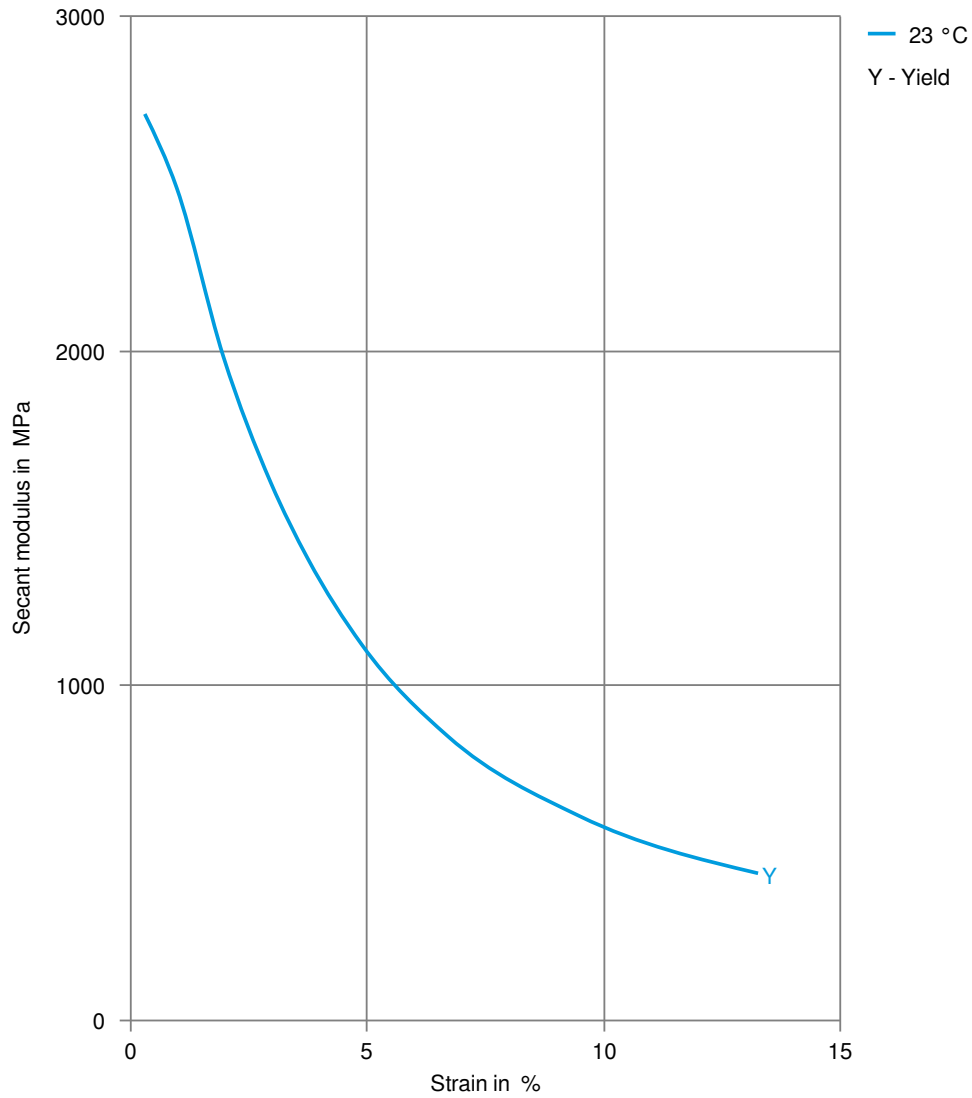
OEM	STANDARD	ADDITIONAL INFORMATION
Honda	Interior	
Hyundai	MS237-05 Type A-1	
Mercedes-Benz	DBL5404	BQF
VW Group	TL 524 76	Black Only -Porsche-Grammer-Ros- Center Console / Arm Rest-SlideX

Stress-strain



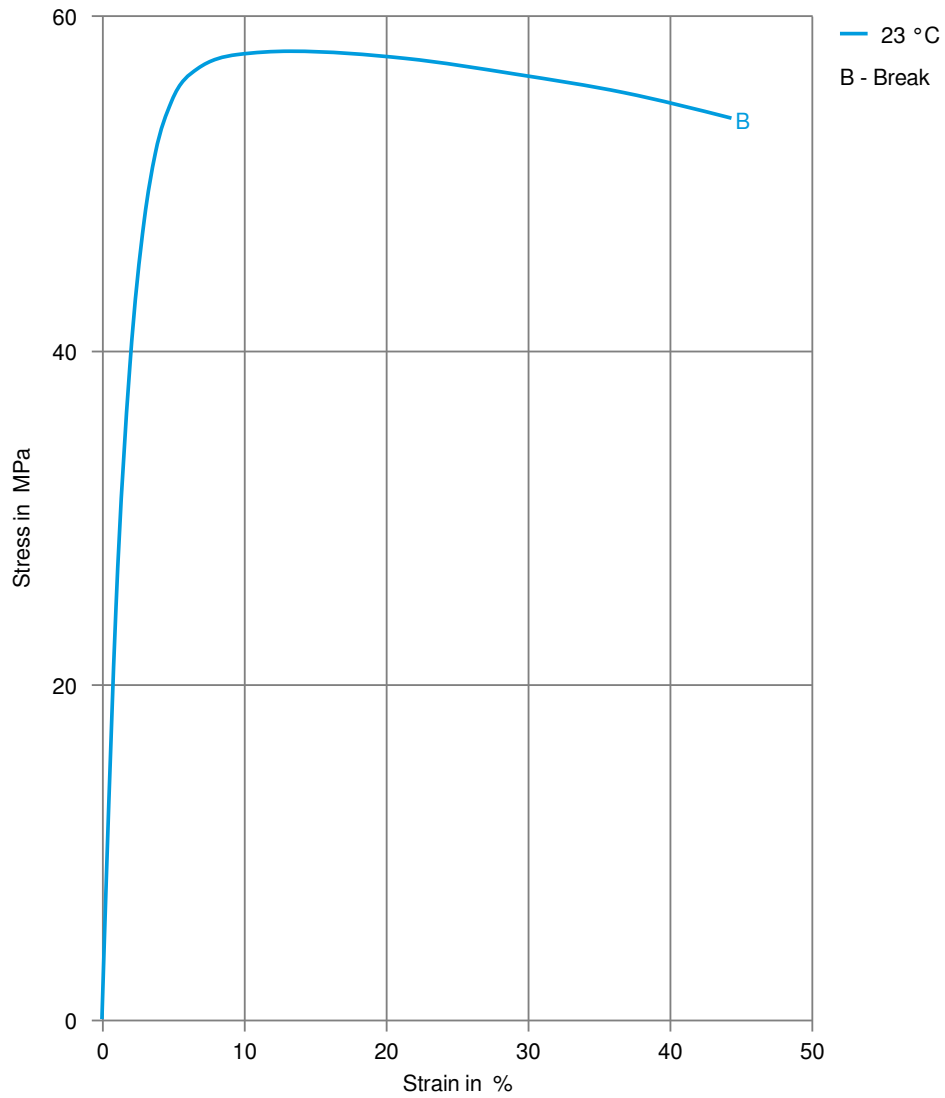
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Secant modulus-strain



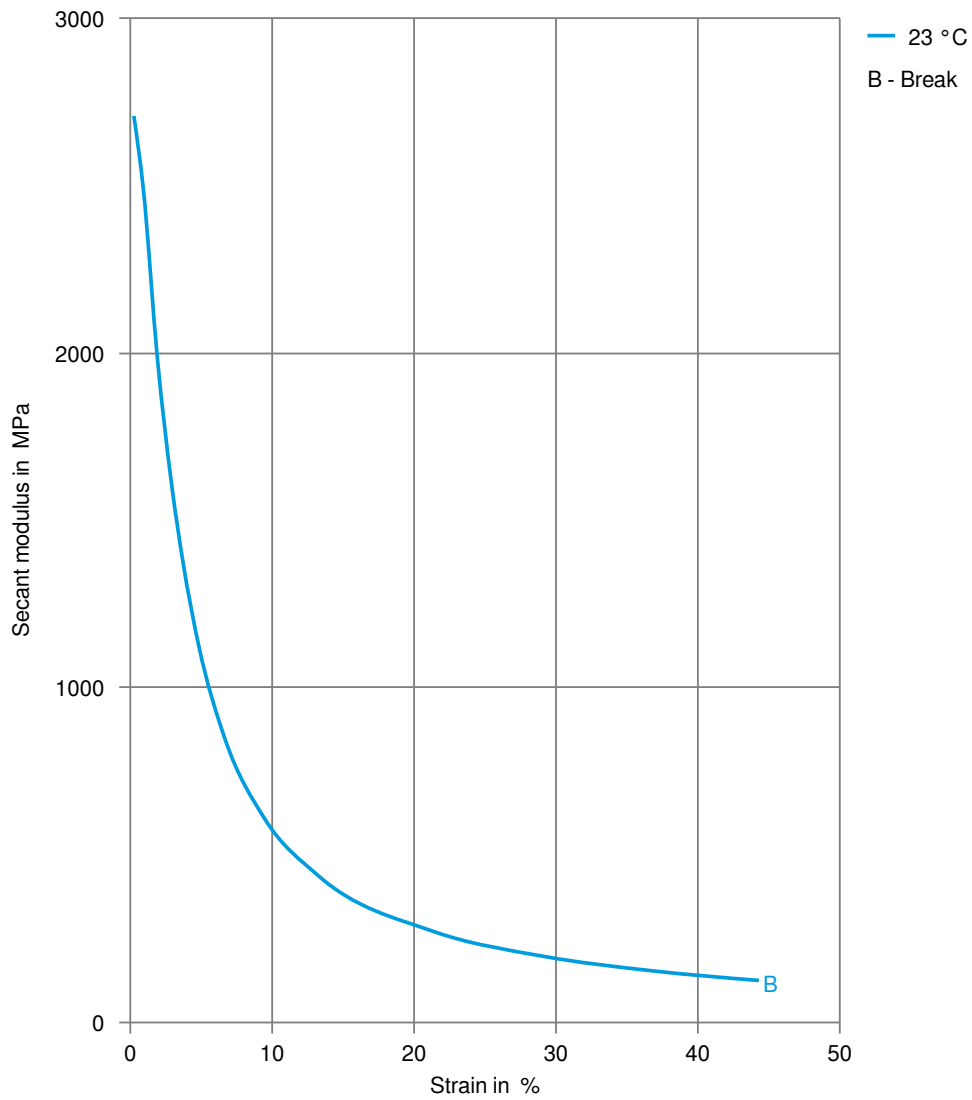
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Stress-strain, 50mm/min



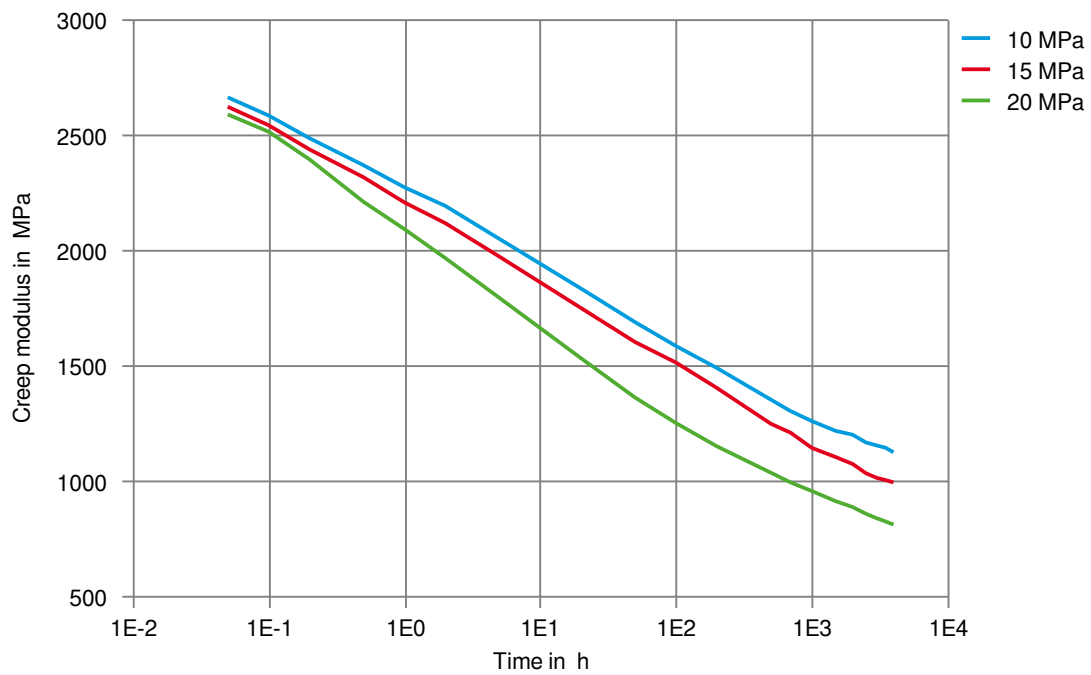
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Secant modulus-strain, 50mm/min



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Creep modulus-time 23°C



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Creep strain-time 23°C

